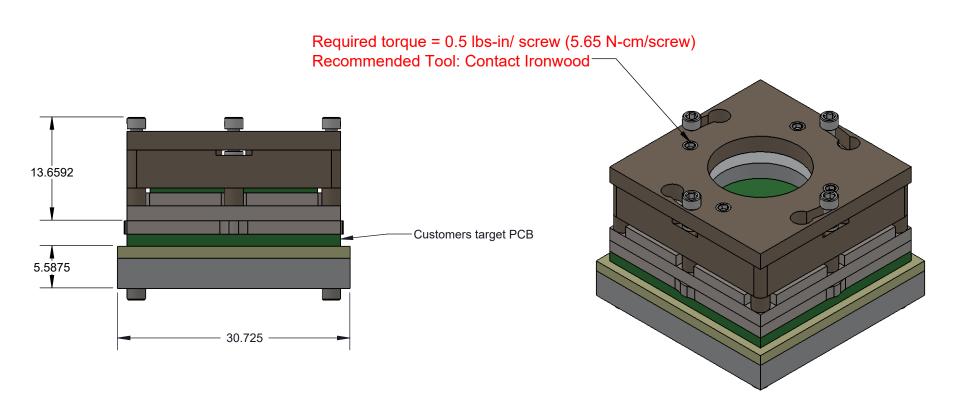
# SBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR BURN-IN AND TEST APPLICATIONS

#### **Features**

- Wide temperature range (-55C to +180C)
  High current capability (up to 4A)
  Excellent signal integrity at high frequencies
  Low and stable contact resistance for reliable production yield
  Highly compliant to accommodate wide co-planarity variations
  Automated probe manufacturing enables low cost and short lead time



### **Description: Socket Spec**

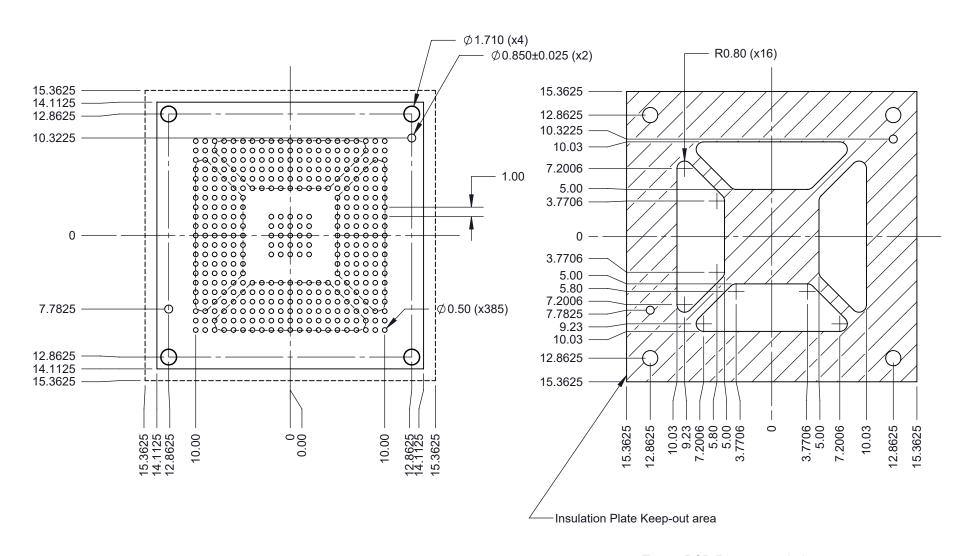
Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	SBT-BGA-6018 Drawing	Material: N/A	STATUS: Released	SHEET: 1 OF 4	REV. A
8	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com		ENG: M. Tully	SCALE: 2:1	
		Weight. 30.00	FILE: SBT-BGA-6018 Dwg	DATE: 4/2/2013	



# Note: BGA pattern is NOT symmetrical with respect to the mounting holes.



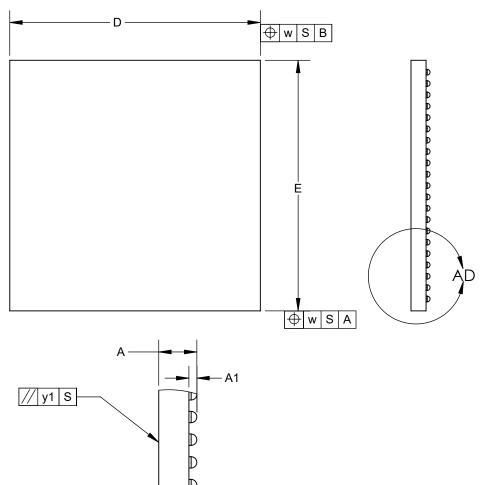
Target PCB Recommendations
Total thickness: 1.6mm min.
Plating: Gold or Solder finish
PCB Pad height: Same or higher than solder mask

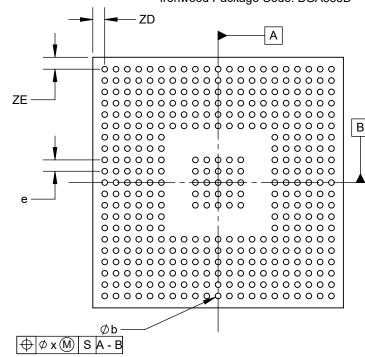
## **Description: Recommended Layout**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SBT-BGA-6018 Drawing		Material: N/A	STATUS: Released	SHEET: 2 OF 4	REV. A
	Ironwood Electronics, Inc.	Finish: N/A Weight: 30.80	ENG: M. Tully	SCALE: 2.5:1	
	Tele: (800) 404-0204 www.ironwoodelectronics.com	Weight. 30.00	FILE: SBT-BGA-6018 Dwg	DATE: 4/2/2013	





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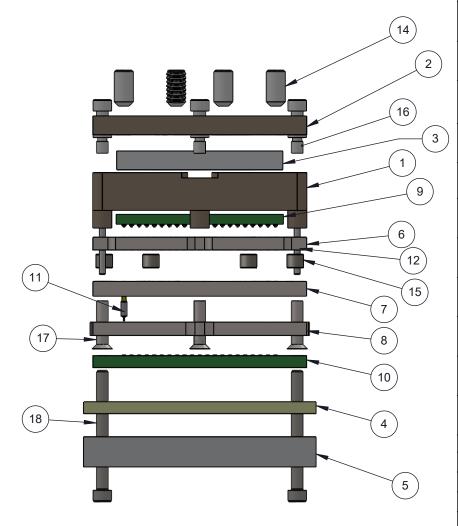
Dimension (mm)
22.00±0.10
22.00±0.10
0.30
1.83±0.20
0.50±0.10
1.33
1.00
0.60±0.10
0.1
0.15
0.35
1.00
1.00

### **Description: BGA Spec**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SI	BT-BGA-6018 Drawing	Material: N/A	STATUS: Released	SHEET: 3 OF 4	REV. A
	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	Finish: N/A Weight: 30.80	ENG: M. Tully	SCALE: 3:1	
		Weight. 30.00	FILE: SBT-BGA-6018 Dwg	DATE: 4/2/2013	



ITEM NO.	DESCRIPTION	Material
1	Ni plated Socket Base for 22x22mm IC	7075-T6 Aluminum Alloy
2	Ni plated Socket Lid for 22x22mm IC	7075-T6 Aluminum Alloy
3	Ni plated compression plate for 22x22mm IC w/ 14mm hole	7075-T6 Aluminum Alloy
4	Insulation plate for 23x23mm IC	FR4 High temp
5	SBT/CBT NI PLT BACKING PLT 23MM	7075-T6, Plate (SS)
6	Floating Guide 23X23mm 1mm 22x22 array	PEEK Ceramic filled
7	Middle Guide 22X22mm 1mm 21x21 array	PEEK Ceramic filled
8	Bottom Guide 22X22mm 1mm 21x21 array	PEEK Ceramic filled
9	BGA385 chip, 22x22mm, 21x21array, 1mm pitch	Material <not specified=""></not>
10	Target PCB for 22x22mm; 1mm, 21x21	Material <not specified=""></not>
11	Pogo Pin, 1mm Pitch SBT BGA pin	
12	Dowel Pin, 1/32" x 3/8", SS	Chrome Stainless Steel
13	3-48 set screw	Black-Oxide Alloy Steel
14	3-48 set screw, flat point	Black-Oxide Alloy Steel
15	Floating Guide Spring	Alloy Steel (SS)
16	#0-80 Shoulder Screw, 1.59mm thread length	Stainless Steel (303)
17	#0-80X0.25", 90 deg., head pin guide screw, Peek material	PEEK unfilled
18	#0-80 X .625 LG, SOC HD CAP SCREW, SS	Stainless Steel (ferritic)

## **Description: Exploded View**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SBT-BGA-6018 Drawing	Material: N/A	STATUS: Released	SHEET: 4 OF 4	REV. A
Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	Finish: N/A Weight: 30.80	ENG: M. Tully	SCALE: 2:1	
	Weight. 30.00	FILE: SBT-BGA-6018 Dwg	DATE: 4/2/2013	